



Vincotech

flowPACK E2 SiC		1200 V / 11 mΩ
Topology features		
<ul style="list-style-type: none">• 3ph Inverter• Low and high side Kelvin Emitter for improved switching performance• MOSFET• Open Emitter configuration• Temperature sensor		
Component features		flow E2 12 mm housing
<ul style="list-style-type: none">• High Blocking Voltage with low drain source on state resistance• High speed SiC-MOSFET technology• Resistant to Latch-up		
Housing features		
<ul style="list-style-type: none">• Base isolation: Al₂O₃• Convex shaped substrate for superior thermal contact• Compact housing• CTI600 housing material• Thermo-mechanical push-and-pull force relief• Press-fit pin• Reliable cold welding connection		
Target applications		Schematic
<ul style="list-style-type: none">• Charging Stations• Elevator Drives• Embedded Drives• Industrial Drives• Servo Drives		
Types		
<ul style="list-style-type: none">• 10-EY126PB011ME-PJ19F18T		



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Maximum Ratings

$T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Drain-source voltage	V_{DSS}		1200	V
Drain current (DC current)	I_D	$T_j = T_{jmax}$	102	A
Peak drain current	I_{DM}	t_p limited by T_{jmax}	400	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	160	W
Gate-source voltage	V_{GSS}		-4 / 15	V
		dynamic	-8 / 19	
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				>12,7	mm
Clearance				9,11	mm
Comparative Tracking Index	CTI			≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

Inverter Switch

Static

Drain-source on-state resistance	$r_{DS(on)}$		15		122	25 125 150	7,25	10,4 13,3 14,8	13,5 ⁽¹⁾	mΩ
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$			0,0336	25	1,8	2,5	3,6	V
Gate to Source Leakage Current	I_{GSS}		15	0		25		20	200	nA
Zero Gate Voltage Drain Current	I_{DSS}		0	1200		25		2	50	µA
Internal gate resistance	r_g							1,65		Ω
Gate charge	Q_g		-4/15	800	122	25		324		nC
Short-circuit input capacitance	C_{iss}	$f = 100$ kHz	0	1000	0	25		9636		pF
Short-circuit output capacitance	C_{oss}							360		
Reverse transfer capacitance	C_{rss}							24		
Diode forward voltage	V_{SD}		0		61	25		4,6		V

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,59		K/W
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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Dynamic										
Turn-on delay time	$t_{d(on)}$				25 125 150		21,31 20,24 20			ns
Rise time	t_r				25 125 150		16,56 14,12 13,59			ns
Turn-off delay time	$t_{d(off)}$		$R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$		25 125 150		73,96 81,65 83,76			ns
Fall time	t_f				25 125 150		17,51 17,85 18,28			ns
Turn-on energy (per pulse)	E_{on}	$Q_{fFWD}=0,688 \mu C$ $Q_{fFWD}=1,58 \mu C$ $Q_{fFWD}=1,96 \mu C$		-4/15	600	120	2,46 2,75 2,89			mWs
Turn-off energy (per pulse)	E_{off}				25 125 150		0,747 0,8 0,809			mWs
Peak recovery current	I_{RRM}				25 125 150		45,15 64,21 83,22			A
Reverse recovery time	t_{rr}				25 125 150		26,77 37,13 38,56			ns
Recovered charge	Q_r	$di/dt=3339 A/\mu s$ $di/dt=3979 A/\mu s$ $di/dt=4909 A/\mu s$			25 125 150		0,688 1,58 1,96			μC
Reverse recovered energy	E_{rec}				25 125 150		0,107 0,416 0,552			mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$				25 125 150		5060,02 9747,54 14090,2			A/μs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max

Thermistor

Static

Rated resistance	R					25		5		kΩ	
Deviation of R100	$A_{R/R}$	$R_{100} = 499 \Omega$				100		3,2		3,3	%
Power dissipation	P					25		130		mW	
Power dissipation constant	d					25		1,3		mW/K	
B-value	$B_{(25/50)}$	Tol. ±1 %						3380		K	
Vincotech Thermistor Reference									V		

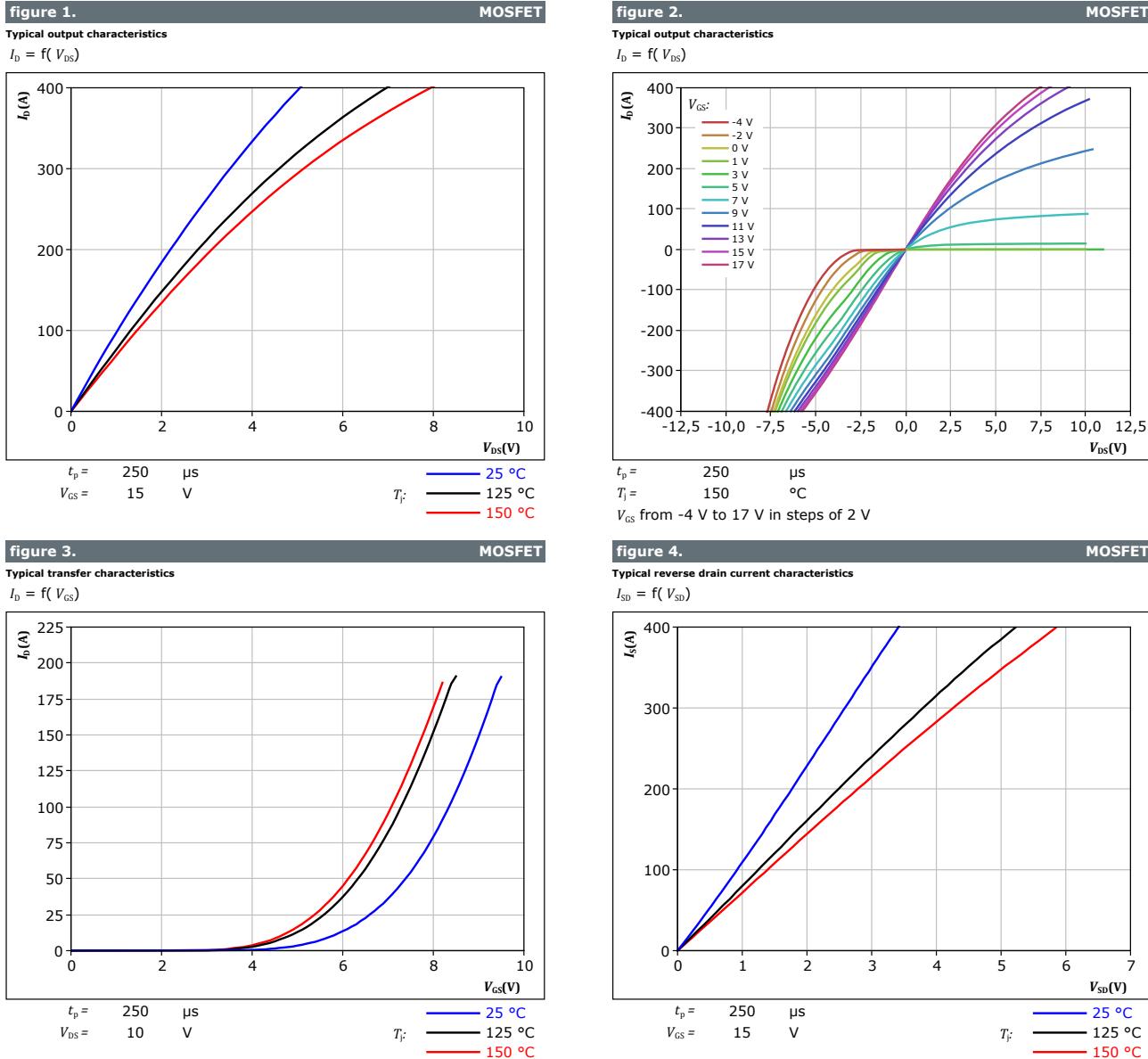
⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



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Inverter Switch Characteristics





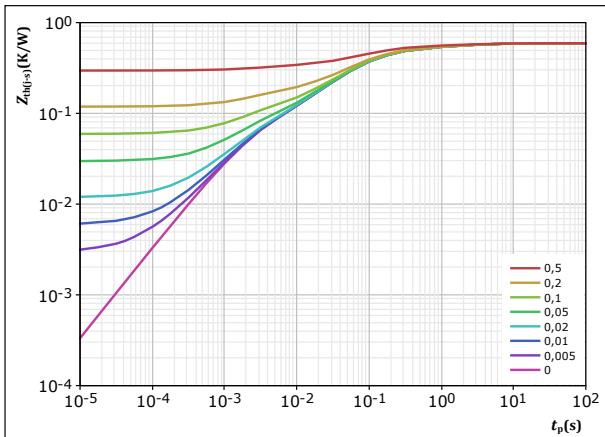
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Inverter Switch Characteristics

figure 5.

Transient thermal impedance as a function of pulse width

$$Z_{\text{th}(\cdot-s)} = f(t_p)$$



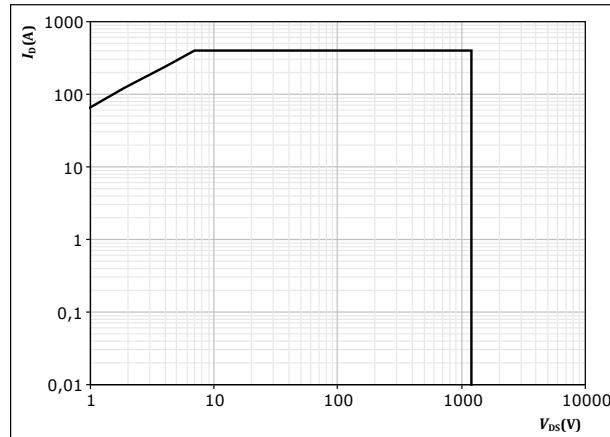
$D = \frac{t_p}{T}$
 $R_{\text{th}(\cdot-s)} = 0,592 \text{ K/W}$
MOSFET thermal model values
 $R (\text{K/W}) \quad \tau (\text{s})$
5,20E-02 3,40E+00
8,39E-02 5,42E-01
2,55E-01 9,89E-02
1,45E-01 3,19E-02
5,67E-02 2,18E-03

MOSFET

figure 6.

Safe operating area

$$I_D = f(V_{DS})$$

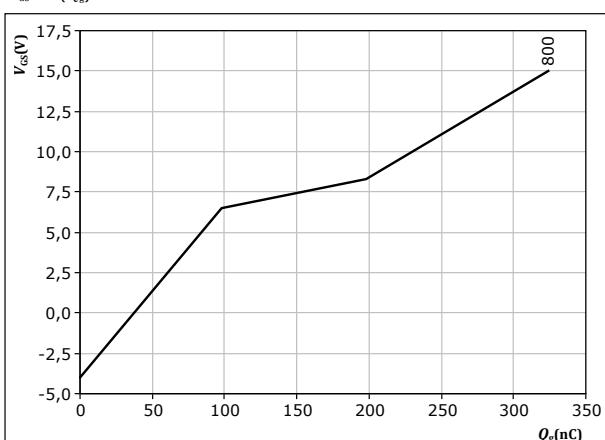


$D = \text{single pulse}$
 $T_s = 80^\circ\text{C}$
 $V_{GS} = 15 \text{ V}$
 $T_j = T_{j,\max}$

figure 7.

Gate voltage vs gate charge

$$V_{GS} = f(Q_g)$$

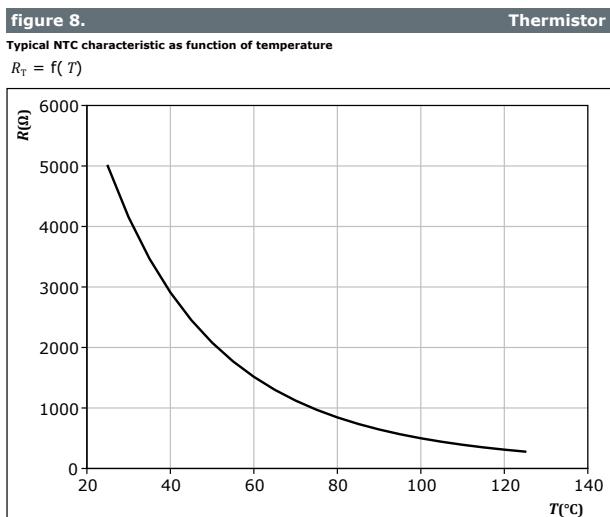


$I_D = 61 \text{ A}$
 $T_j = 25^\circ\text{C}$

MOSFET



Thermistor Characteristics



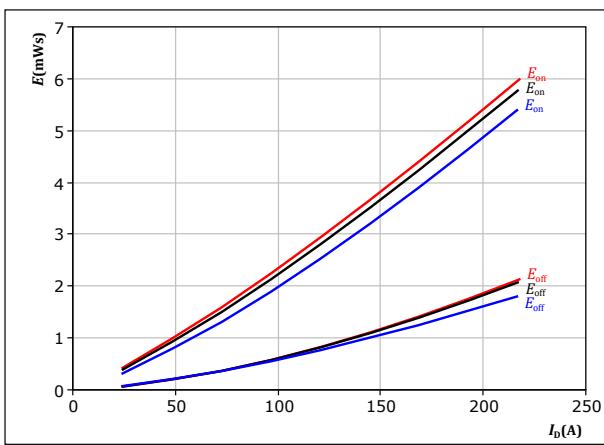


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Inverter Switching Characteristics

figure 9.

Typical switching energy losses as a function of drain current
 $E = f(I_D)$



With an inductive load at

$V_{DS} = 600$ V $T_f:$ 25 °C
 $V_{GS} = -4/15$ V 125 °C
 $R_{gon} = 2$ Ω 150 °C
 $R_{goff} = 2$ Ω

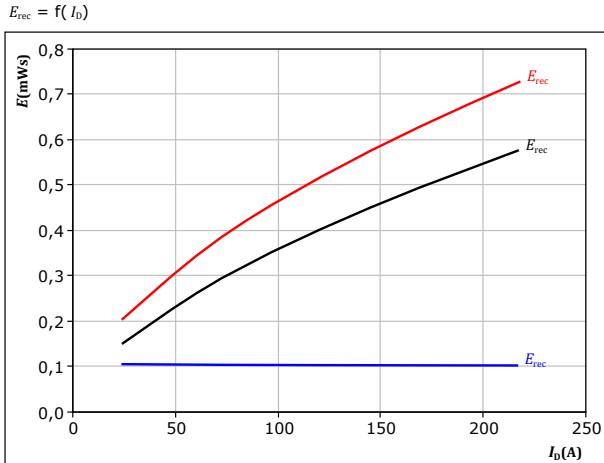
figure 10.

Typical switching energy losses as a function of MOSFET turn on gate resistor
 $E = f(R_g)$

With an inductive load at
 $V_{DS} = 600$ V $T_f:$ 25 °C
 $V_{GS} = -4/15$ V 125 °C
 $I_D = 120$ A 150 °C

figure 11.

Typical reverse recovered energy loss as a function of drain current
 $E_{rec} = f(I_D)$

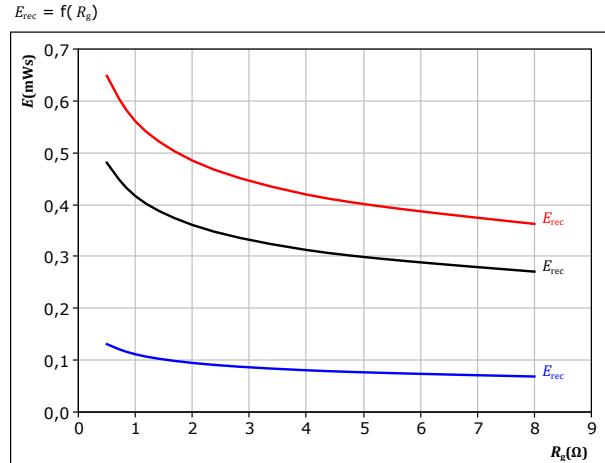


With an inductive load at

$V_{DS} = 600$ V $T_f:$ 25 °C
 $V_{GS} = -4/15$ V 125 °C
 $R_{gon} = 2$ Ω 150 °C

figure 12.

Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at
 $V_{DS} = 600$ V $T_f:$ 25 °C
 $V_{GS} = -4/15$ V 125 °C
 $I_D = 120$ A 150 °C

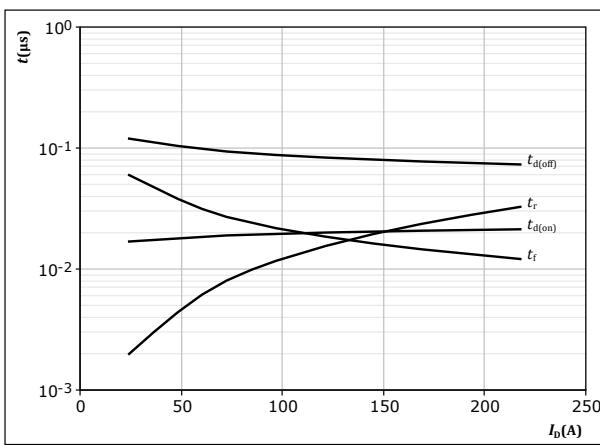


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Inverter Switching Characteristics

figure 13.

Typical switching times as a function of drain current
 $t = f(I_D)$



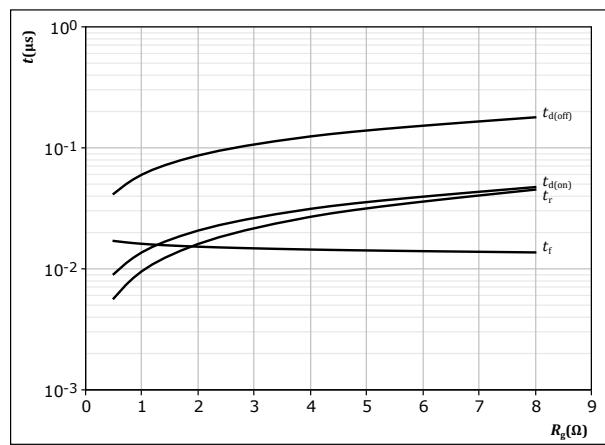
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{DS} = 600 \text{ V}$
 $V_{GS} = -4/15 \text{ V}$
 $R_{gon} = 2 \Omega$
 $R_{goff} = 2 \Omega$

MOSFET

figure 14.

Typical switching times as a function of MOSFET turn on gate resistor
 $t = f(R_g)$



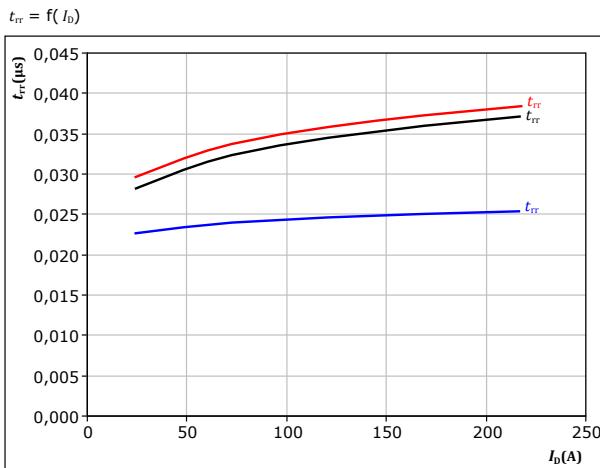
With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{DS} = 600 \text{ V}$
 $V_{GS} = -4/15 \text{ V}$
 $I_D = 120 \text{ A}$

MOSFET

figure 15.

Typical reverse recovery time as a function of drain current
 $t_{rr} = f(I_D)$

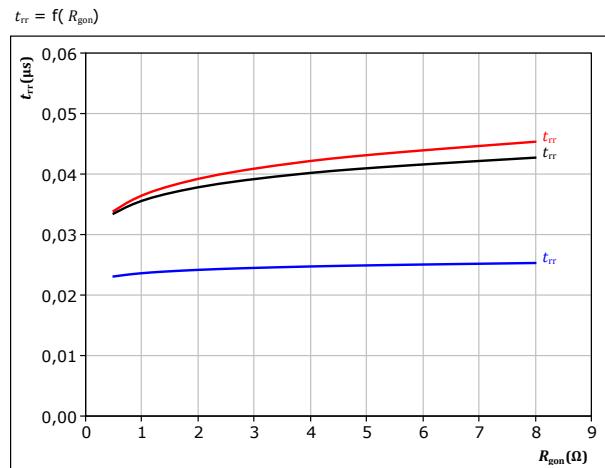


At $V_{DS} = 600 \text{ V}$
 $V_{GS} = -4/15 \text{ V}$
 $R_{gon} = 2 \Omega$

MOSFET

figure 16.

Typical reverse recovery time as a function of MOSFET turn on gate resistor
 $t_{rr} = f(R_{gon})$



At $V_{DS} = 600 \text{ V}$
 $V_{GS} = -4/15 \text{ V}$
 $I_D = 120 \text{ A}$



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Inverter Switching Characteristics

figure 17.

Typical recovered charge as a function of drain current
 $Q_r = f(I_D)$

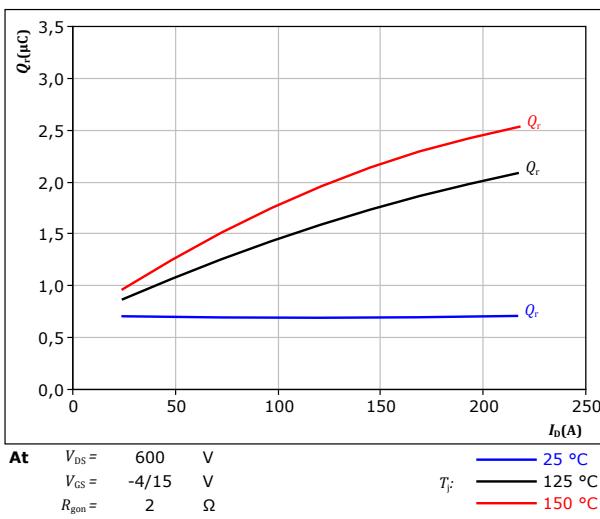


figure 19.

Typical peak reverse recovery current as a function of drain current
 $I_{RM} = f(I_D)$

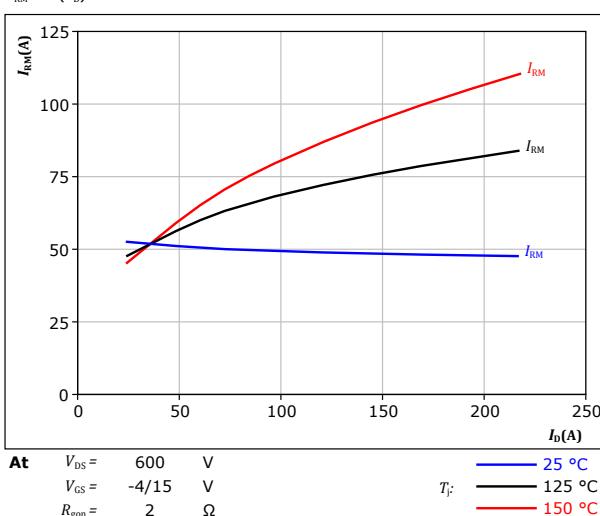


figure 18.

Typical recovered charge as a function of MOSFET turn on gate resistor
 $Q_r = f(R_{gon})$

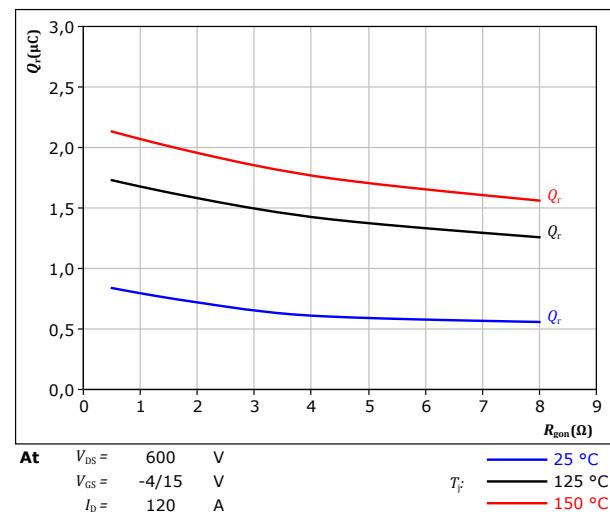
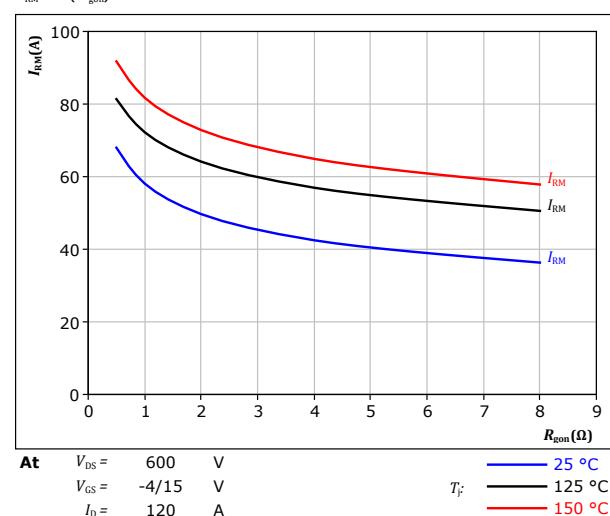


figure 20.

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor
 $I_{RM} = f(R_{gon})$





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Inverter Switching Characteristics

figure 21. MOSFET

Typical rate of fall of forward and reverse recovery current as a function of drain current
 $di_f/dt, di_{rr}/dt = f(I_D)$

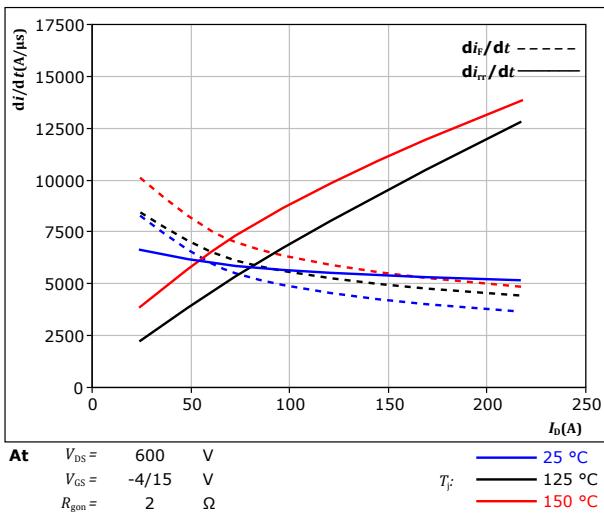


figure 22. MOSFET

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$

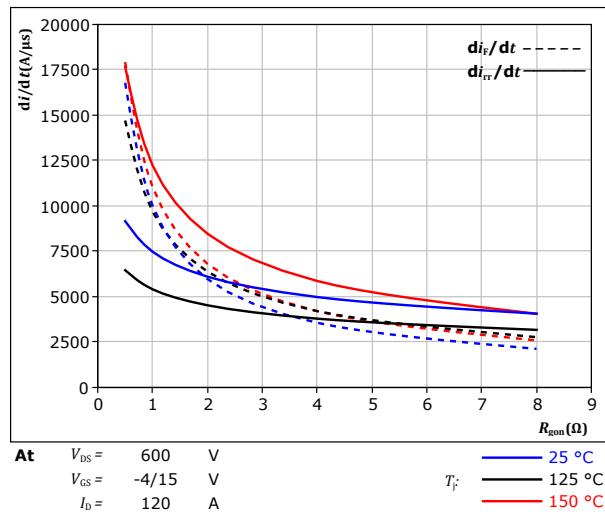
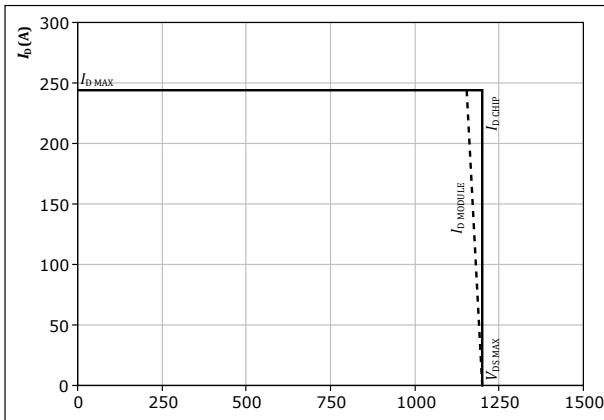


figure 23. MOSFET

Reverse bias safe operating area

$I_D = f(V_{DS})$





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Inverter Switching Definitions

figure 24. MOSFET

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

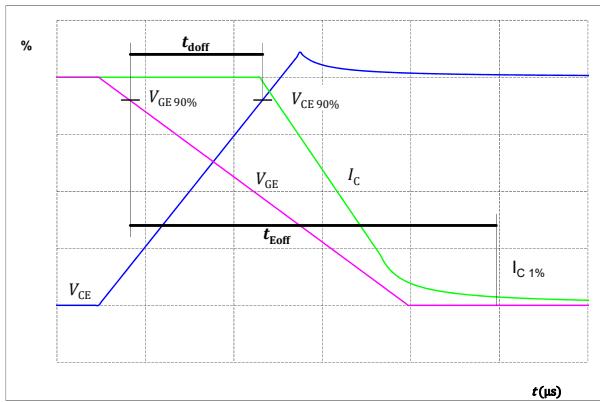


figure 25. MOSFET

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

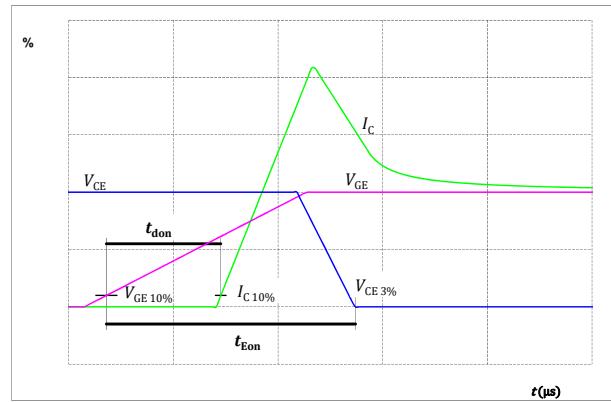


figure 26. MOSFET

Turn-off Switching Waveforms & definition of t_f

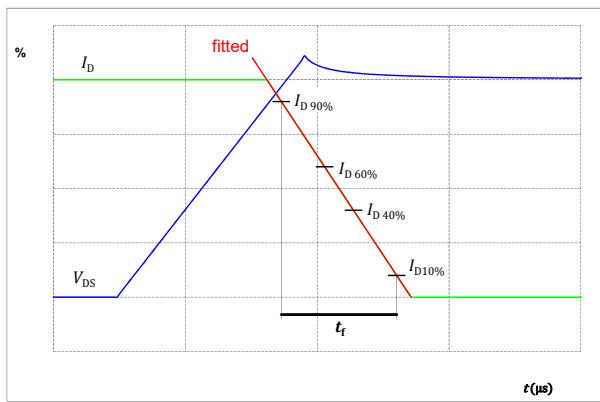
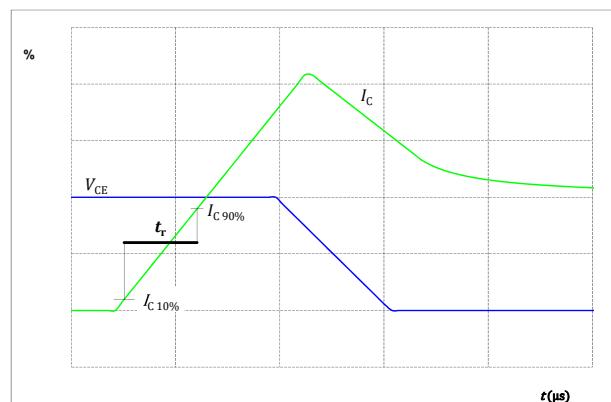


figure 27. MOSFET

Turn-on Switching Waveforms & definition of t_r





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Inverter Switching Definitions

figure 28.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

Turn-off Switching Waveforms & definition of t_{tr}

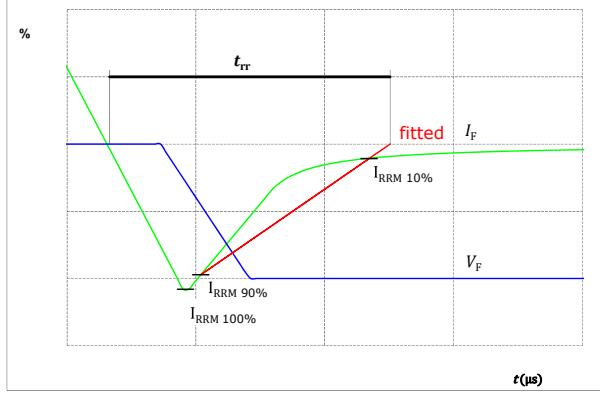


figure 29.

Turn-on Switching Waveforms & definition of t_{Qtr} (t_{Qtr} = integrating time for Q_{tr})

FWD

Turn-on Switching Waveforms & definition of t_{Qtr} (t_{Qtr} = integrating time for Q_{tr})

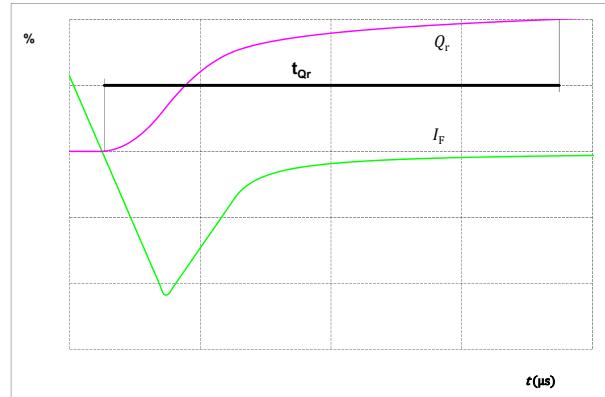
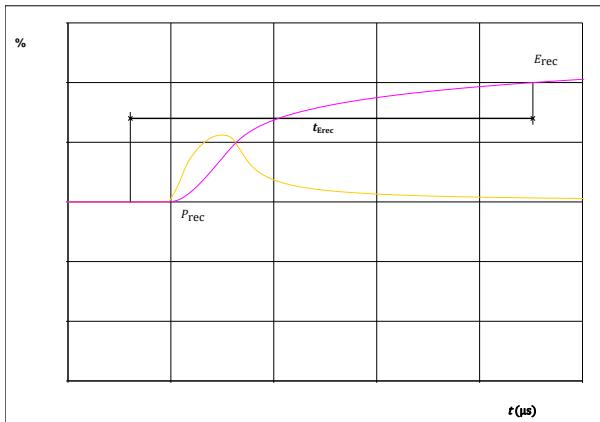


figure 30.

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})

FWD

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})





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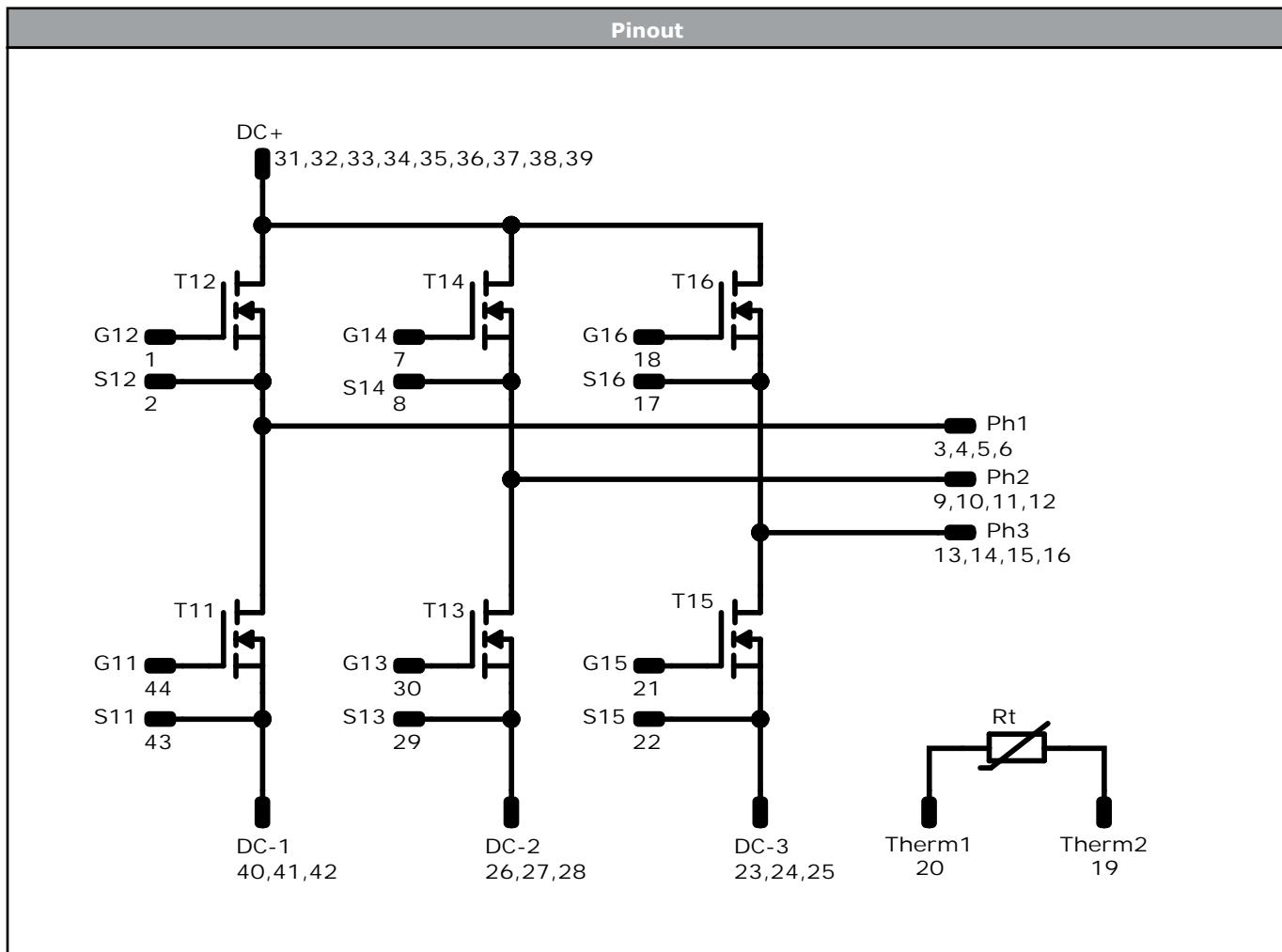
Ordering Code	
Version	Ordering Code
Without thermal paste	10-EY126PB011ME-PJ19F18T
With thermal paste (5,2 W/mK, PTM6000HV)	10-EY126PB011ME-PJ19F18T-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-EY126PB011ME-PJ19F18T-/3/

Marking						
Text	Name		Date code	UL & VIN	Lot	Serial
	NN-NNNNNNNNNNNNNN TTTTTTVV	VIN LLLL SSSS	WWYY	UL VIN	LLLLL	SSSS
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTVV	LLLLL	SSSS	WWYY		

Outline			
Pin table [mm]			
Pin	X	Y	Function
1	6,4	0	G12
2	3,2	0	S12
3	0	0	Ph1
4	0	3,2	Ph1
5	0	6,4	Ph1
6	0	9,6	Ph1
7	6,4	19,2	G14
8	3,2	19,2	S14
9	0	19,2	Ph2
10	0	22,4	Ph2
11	0	25,6	Ph2
12	0	28,8	Ph2
13	3,2	38,4	Ph3
14	0	38,4	Ph3
15	0	41,6	Ph3
16	0	44,8	Ph3
17	0	48	S16
18	3,2	48	G16
19	12,8	48	Therm2
20	22,4	48	Therm1
21	25,6	48	G15
22	28,8	48	S15
23	32	48	DC-3
24	32	44,8	DC-3
25	32	41,6	DC-3
26	32	25,6	DC-2
27	32	22,4	DC-2
28	32	19,2	DC-2
29	32	16	S13
30	28,8	19,2	G13
31	22,4	12,8	DC+
32	19,2	12,8	DC+
33	16	12,8	DC+
34	19,2	16	DC+
35	22,4	16	DC+
36	25,6	32	DC+
37	22,4	32	DC+
38	22,4	35,2	DC+
39	25,6	35,2	DC+
40	32	6,4	DC-1
41	32	3,2	DC-1
42	32	0	DC-1
43	28,8	0	S11
44	25,6	0	G11



Vincotech



Identification

ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	MOSFET	1200 V	10,5 mΩ	Inverter Switch	
Rt	Thermistor			Thermistor	



Vincotech

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction				
Handling instructions for flow E2 packages see vincotech.com website.				

Package data				
Package data for flow E2 packages see vincotech.com website.				

Vincotech thermistor reference				
See Vincotech thermistor reference table at vincotech.com website.				

UL recognition and file number				
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.				



Document No.:	Date:	Modification:	Pages
10-EY126PB011ME-PJ19F18T-D1-14	15 Dec. 2023		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.